

12-13-2001

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1. Name of Conveying Part(ies):

Jigish D. Trivedi
Zhongze Wang
Chih-Chen ChoMRID
10.24.01Additional name(s) of conveying
party(ies) attached?☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.

Internal Address: _____

Street Address: 8000 South Federal WayCity: Boise State: ID Zip: 83706-9632Additional names(s) & address(es) attached: ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Security Agreement
☐ Merger ☐ Change of Name
☐ Other _____Execution Date: 10/15/01; 10/16/01; 10/16/01

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:
10/15/01; 10/16/01; 10/16/01

A. Patent Application No.(s): Unknown

10002335

B. Patent No.(s)

Additional numbers attached: ☐ Yes ☒ NoAdditional numbers attached: ☐ Yes ☐ No5. Name and address of party to whom
correspondence concerning document should be
mailed:Name: Mark S. Matkin, Esq.Internal Address: Wells, St. John, Roberts,Gregory & Matkin P.S.Street Address: 601 W. First Avenue, Ste. 1300City: Spokane State: WA Zip: 99201-38286. Total number of applications and
patents involved. 1

7. Total fee (37 CFR 3.41). \$ 40

☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number

23-0925

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and Signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached
copy is a true copy of the original document.Mark S. Matkin

Name of Person Signing

Signature

10-24-01

Date

TOTAL NUMBER OF PAGES INCLUDING COVER SHEET, ATTACHMENTS AND DOCUMENT: 5

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REEL: 012354 FRAME: 0639

ASSIGNMENT

PARTIES TO THE ASSIGNMENT:

INVENTOR:

Jigish D. Trivedi
Zhongze Wang

ASSIGNEE:

Micron Technology, Inc.
Corporation of the State of Delaware
8000 South Federal Way
Boise, Idaho 83716

BACKGROUND OF THIS ASSIGNMENT:

Inventors have conceived certain new and useful inventions disclosed in a United States patent application titled "Methods of Forming Conductive Contacts".

MICRON TECHNOLOGY, INC. (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title and interest in said inventions and with respect to any Letters Patent that may be granted with respect to the inventions in both the United States and in all foreign countries.

THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt sufficiency and adequacy of which is hereby acknowledged, INVENTORS hereby sell, assign and transfer to ASSIGNEE the entire right, title and interest in the above-identified application executed currently with this assignment and to any reissues, renewals, divisions or continuations thereof, and hereby authorizes the

Commissioner of Patents and Trademarks to issue such Letters Patent to ASSIGNEE for the sole use of ASSIGNEE, its successors or assigns.


INVENTORS further agree to execute, at the request and expense of ASSIGNEE such other formal documents as may be required to fully convey the interest transferred herein and will similarly execute any application papers required for the filing of any division, continuation, renewal or reissue of the patent application or resulting Letters Patent; and will generally do everything necessary or desirable to obtain and enforce proper protection for the inventions assigned hereby.

INVENTORS further assign to ASSIGNEE the whole right, title and interest in the inventions disclosed in the application throughout all countries foreign to the United States. ASSIGNEE is hereby authorized to apply for patents relating to the inventions in its own name in countries where such procedure is proper; to claim the benefit of the International Convention; to file and prosecute International Applications relating to the inventions under the Patent Cooperation Treaty; and to file and prosecute applications relating to the inventions under the European Patent Convention. INVENTORS agree to execute applications relating to the inventions in those countries and under those conventions where it is necessary that the same be executed by the inventor, and to execute assignments of such applications and the resulting Letters Patent to ASSIGNEE as well as all other necessary papers in relation to such applications and the resulting Letters Patent to ASSIGNEE as well as all other necessary papers in relation to such applications and Letters Patent.

INVENTORS further warrant and covenant that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full rights to convey the same as herein expressed is possessed by the undersigned.

To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignees.

Dated: 10/15/2001

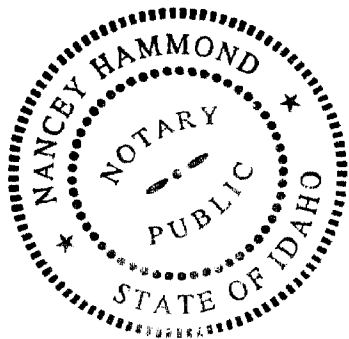
Signature: 
Jigish D. Trivedi

State of Idaho

County of Ada

BEFORE ME, this 15th day of October, 2001, personally appeared the above-named inventor, known to me to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her own free will for the purpose therein expressed.

SEAL



Nancy Hammond
Notary or Consular Officer
My Commission Expires: 6/12/03

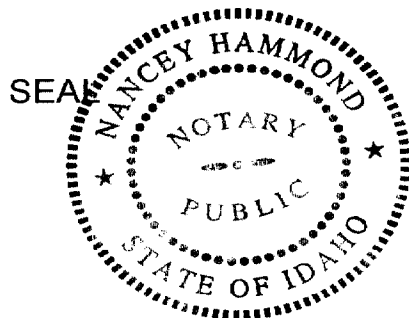
Dated: 10/16/2001

Signature: 
Zhongze Wang

State of Idaho

County of Ada

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Nancy Hammond
Notary or Consular Officer
My Commission Expires: 6/12/03

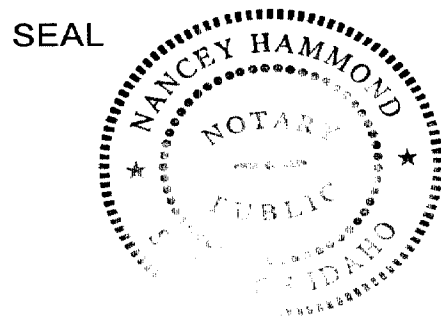
Dated: 10/16/2001

Signature: 
Chih-Chen Cho

State of Idaho

County of Ada

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My Commission Expires: 6/12/03